

WSB5551M

1A Low leakage current Schottky Barrier Diode

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Features

- Ultra low reverse leakage current
- Extremely low thermal resistance
- High current capability



SMA (DO-214AC)



Applications

Circuit



Absolute maximum ratings

Parameter	Symbol	Value	Unit
Reverse voltage (repetitive peak)	V_{RRM}	40	V
Reverse voltage (DC)	V_R	40	V
Average rectified forward current (DC)	I_o	1.0	A
Forward Peak Surge Current ⁽¹⁾	I_{FSM}	40	A
Junction temperature	T_J	-55 ~ 150	°C
Operating temperature	T_{opr}	-55 ~ 150	°C
Storage temperature	T_{stg}	-55 ~ 150	°C

Electronics characteristics ($T_A=25^\circ C$)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward voltage ⁽²⁾	V_F	$I_F=1A$		0.52	0.60	V
Reverse current	I_R	$V_R=40V$		0.2	10	uA
Junction capacitance	C_J	$V_R=4V, F=1MHz$		71		pF
Thermal resistance	$R_{\theta(J-L)}$	Junction to Lead (Fig.2)		16		K/W

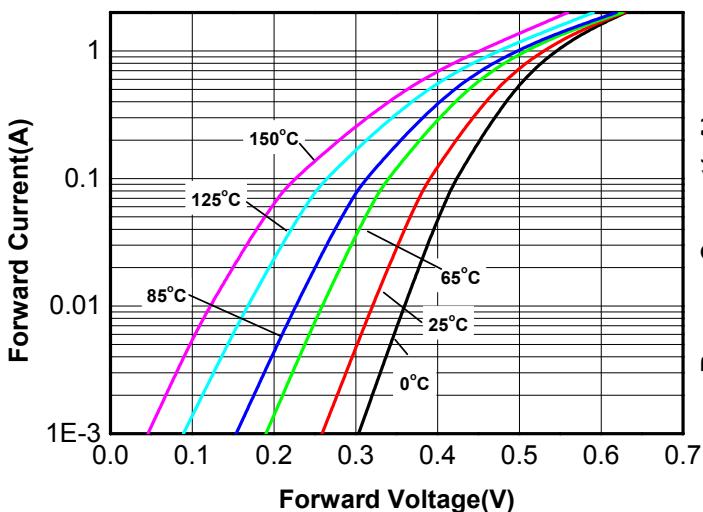
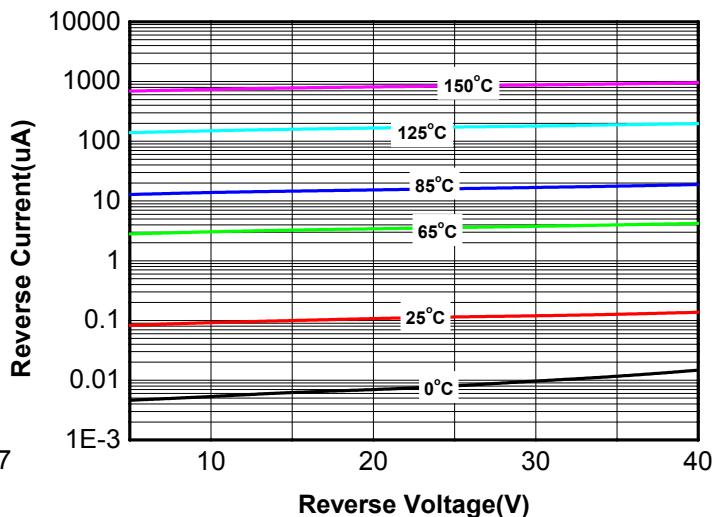
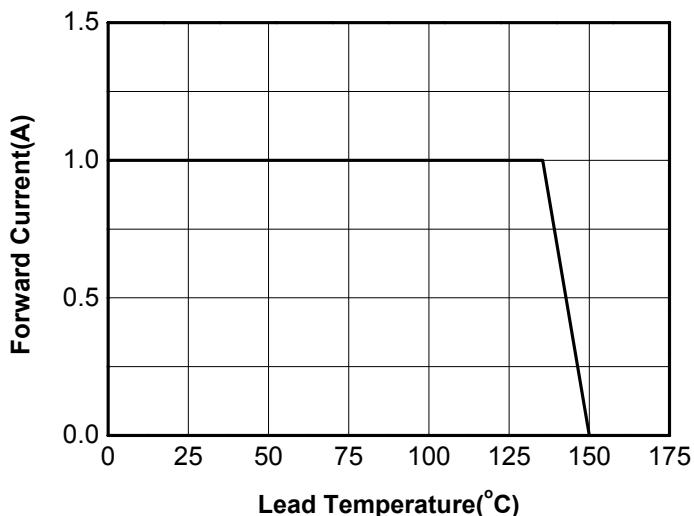
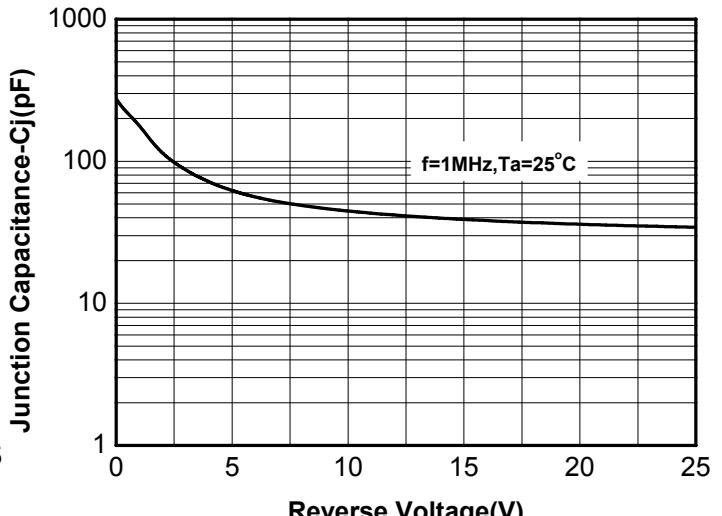
Order Informations

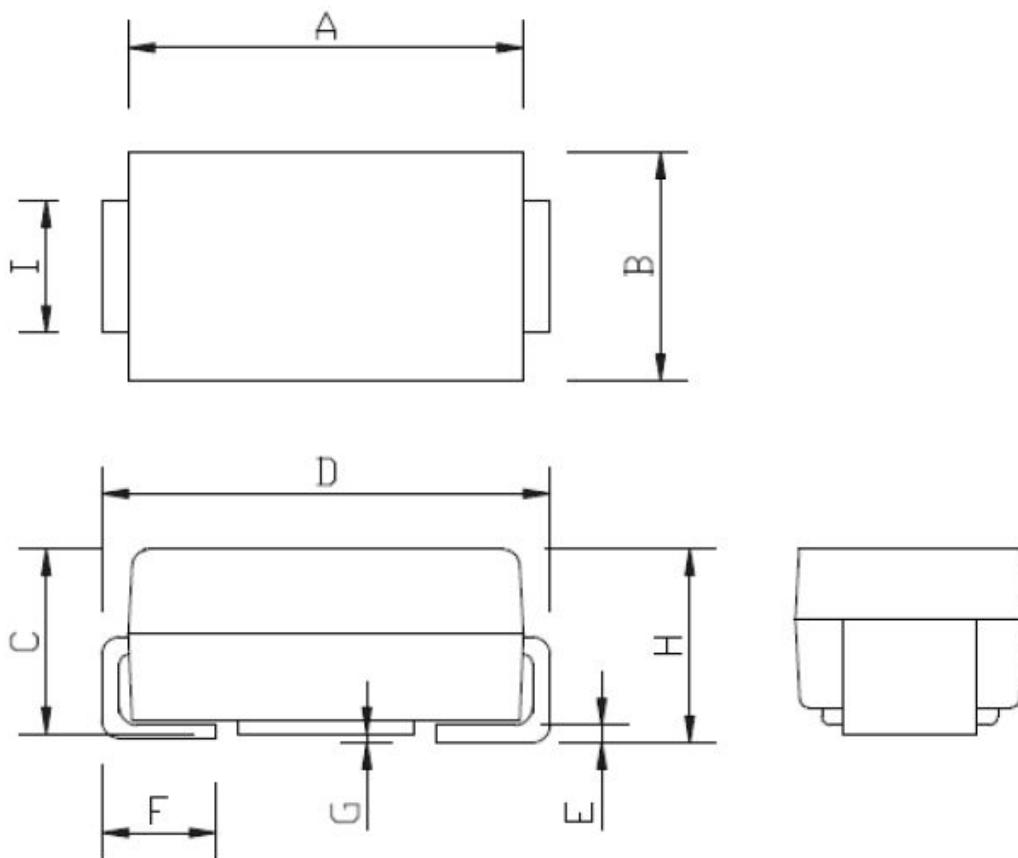
Device	Package	Marking	Shipping
WSB5551M-2/TR	SMA (DO-214AC)	DFB** ⁽³⁾	5000/Reel&Tape

Note1: Pulse width=8.3ms, single pulse;

Note2: Single Pulse, test $T_p=380\mu s$;

Note3: ** =Month code (AA~ZZ); DFB =Device code;

Typical characteristics (Ta=25°C, unless otherwise noted)

Fig.1 Forward voltage vs. Forward current

Fig.2 Reverse current vs. Reverse voltage

Fig.3 Maximum Forward Current Derating Curve

Fig.4 Junction capacitance vs. Reverse voltage

Package outline dimensions
SMA (DO-214AC)


Symbol	Dimensions in millimeter	
	Min.	Max.
A	4.25	4.65
B	2.40	2.80
C	1.85	2.15
D	4.85	5.35
E	0.10	0.30
F	0.90	1.50
G	0.20 Max.	
H	1.90	2.30
I	1.35	1.65